

Mates With Part(s): 50394 Wire-to-Board Terminals, 51110 Wire-to-Board Crimp Housing, 87568 Wire-to-Board IDT Housings, 79107 Board-to-Board Top Entry Through Hole Receptacle, 79108 Board-to-Board FFC/FPC Top Entry Through Hole Receptacle, L

Part Detail

General	
Status	Contact Molex
Category	PCB Headers
Series	<u>87832</u>
Application	Signal, Wire-to-Board
Comments	With Cap, Contact Molex for application in automotive industry
Overview	<u>Milli-Grid™</u>
Product Name	Milli-Grid™
Physical	
Breakaway	No
Circuits (Loaded)	30
Circuits (maximum)	30
Color - Resin	Black
Durability (mating cycles max)	100
First Mate / Last Break	No
Flammability	94V-0
Glow-Wire Compliant	No
Guide to Mating Part	No
Keying to Mating Part	Yes
Lock to Mating Part	Yes
Material - Metal	Phosphor Bronze
Material - Plating Mating	Gold
Material - Plating Termination	Tin
Material - Resin	Nylon
Number of Rows	2
Orientation	Vertical
PCB Locator	No
PCB Retention	None
Packaging Type	Embossed Tape on Reel
Pitch - Mating Interface	2.00mm
Pitch - Termination Interface	2.00mm
Plating min - Mating	0.762μm
Plating min - Termination	1.905µm
Polarized to PCB	No
Robotic Placement	Pick and Place Cap
Shrouded	Fully
Stackable	No
Surface Mount Compatible (SMC)	Yes
Temperature Range - Operating	-55°C to +105°C
Termination Interface: Style	Through Hole and Surface Mount
(Please review the Product Specification for specific details.)	
Current - Maximum per Contact	2A
Voltage - Maximum	125V
Agency Certification	
CSA	LR19980
UL	E29179
Duration at Max. Process Temperature (seconds)	10
Lead-free Process Capability	Reflow Capable (SMT only)

Product Specification Sales Drawing PS-87831-027 SD-87832-007

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Application Tooling

Tooling specifications and manuals are found by selecting the products below.

Crimp Height Specifications are then contained in the Application Tooling Specification document.

Previously Available Application Tooling Check our list of old tooling that used to be available for this part